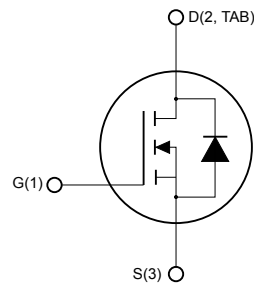
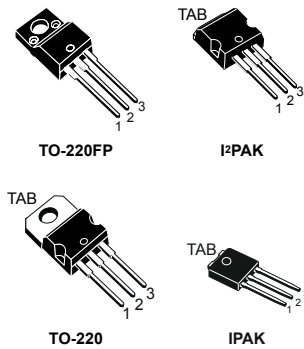


N-channel 600 V, 280 mΩ typ., 11 A MDmesh II Power MOSFETs  
in a TO-220FP, I<sup>2</sup>PAK, TO-220 and IPAK packages



NG1D2TS3



## Features

| Order codes | V <sub>DS</sub> | R <sub>DS(on)</sub> max. | I <sub>D</sub> |
|-------------|-----------------|--------------------------|----------------|
| STF13NM60N  | 600 V           | 360 mΩ                   | 11 A           |
| STI13NM60N  |                 |                          |                |
| STP13NM60N  |                 |                          |                |
| STU13NM60N  |                 |                          |                |

- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance

## Applications

- Switching applications

## Description

These devices are N-channel Power MOSFETs developed using the second generation of MDmesh technology. These revolutionary Power MOSFETs associate a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. They are therefore suitable for the most demanding high-efficiency converters.

### Product status link

[STF13NM60N](#)

[STI13NM60N](#)

[STP13NM60N](#)

[STU13NM60N](#)

# 1 Electrical ratings

**Table 1. Absolute maximum ratings**

| Symbol                         | Parameter   | Value              |                                  | Unit |
|--------------------------------|---|--------------------|----------------------------------|------|
|                                |   | TO-220FP           | I <sup>2</sup> PAK, TO-220, IPAK |      |
| V <sub>DS</sub>                | Drain-source voltage  | 600                |                                  | V    |
| V <sub>GS</sub>                | Gate-source voltage   | ±25                |                                  | V    |
| I <sub>D</sub>                 | Drain current (continuous) at T <sub>C</sub> = 25 °C  | 11 <sup>(1)</sup>  | 11                               | A    |
|                                | Drain current (continuous) at T <sub>C</sub> = 100 °C   | 6.9 <sup>(1)</sup> | 6.9                              |      |
| I <sub>DM</sub> <sup>(2)</sup> | Drain current pulsed  | 44 <sup>(1)</sup>  | 44                               | A    |
| P <sub>TOT</sub>               | Total power dissipation at T <sub>C</sub> = 25 °C   | 25                 | 90                               | W    |
| dv/dt <sup>(3)</sup>           | Peak diode recovery voltage slope   | 15                 |                                  | V/ns |
| V <sub>ISO</sub>               | Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s, T <sub>C</sub> = 25 °C) | 2.5                |                                  | kV   |
| T <sub>J</sub>                 | Operating junction temperature range  | -55 to 150         |                                  | °C   |
| T <sub>stg</sub>               | Storage temperature range   |                    |                                  | °C   |

1. Limited by maximum junction temperature.
2. Pulse width limited by safe operating area.
3. I<sub>SD</sub> ≤ 11 A, di/dt ≤ 400 A/μs, V<sub>DD</sub> = 80% V<sub>(BR)DSS</sub>.

**Table 2. Thermal data**

| Symbol                | Parameter                           | Value    |                            |      | Unit |
|-----------------------|-------------------------------------|----------|----------------------------|------|------|
|                       |                                     | TO-220FP | I <sup>2</sup> PAK, TO-220 | IPAK |      |
| R <sub>thj-case</sub> | Thermal resistance junction-case    | 5        | 1.39                       |      | °C/W |
| R <sub>thj-a</sub>    | Thermal resistance junction-ambient | 62.5     |                            | 100  | °C/W |

**Table 3. Avalanche characteristics**

| Symbol          | Parameter  | Value | Unit |
|-----------------|--|-------|------|
| I <sub>AS</sub> | Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>J</sub> max)                                | 3.5   | A    |
| E <sub>AS</sub> | Single-pulse avalanche energy (starting T <sub>J</sub> = 25 °C, I <sub>D</sub> = I <sub>AS</sub> , V <sub>DD</sub> = 50 V) | 200   | mJ   |

## 2 Electrical characteristics

( $T_C = 25\text{ °C}$  unless otherwise specified)

**Table 4. Static**

| Symbol        | Parameter                         | Test conditions  | Min. | Typ. | Max.      | Unit          |
|---------------|-----------------------------------|--|------|------|-----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage    | $V_{GS} = 0\text{ V}$ , $I_D = 1\text{ mA}$  | 600  |      |           | V             |
| $I_{DSS}$     | Zero gate voltage drain current   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 600\text{ V}$  |      |      | 1         | $\mu\text{A}$ |
|               |                                   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 600\text{ V}$ , $T_C = 125\text{ °C}$ <sup>(1)</sup> |      |      | 100       |               |
| $I_{GSS}$     | Gate-body leakage current         | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 25\text{ V}$                                     |      |      | $\pm 100$ | nA            |
| $V_{GS(th)}$  | Gate threshold voltage            | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                     | 2    | 3    | 4         | V             |
| $R_{DS(on)}$  | Static drain-source on-resistance | $V_{GS} = 10\text{ V}$ , $I_D = 5.5\text{ A}$  |      | 280  | 360       | m $\Omega$    |

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

| Symbol                     | Parameter                     | Test conditions  | Min.                            | Typ. | Max. | Unit |
|----------------------------|-------------------------------|--|---------------------------------|------|------|------|
| $C_{iss}$                  | Input capacitance             | $V_{DS} = 50\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GS} = 0\text{ V}$  | -                               | 790  | -    | pF   |
| $C_{oss}$                  | Output capacitance            |  | -                               | 60   | -    | pF   |
| $C_{rss}$                  | Reverse transfer capacitance  |  | -                               | 3.6  | -    | pF   |
| $C_{oss\text{ eq.}}^{(1)}$ | Equivalent output capacitance | $V_{DS} = 0\text{ to }480\text{ V}$ , $V_{GS} = 0\text{ V}$  | -                               | 135  | -    | pF   |
| $Q_g$                      | Total gate charge             | $V_{DD} = 480\text{ V}$ , $I_D = 11\text{ A}$ , $V_{GS} = 0\text{ to }10\text{ V}$<br>(see Figure 17. Test circuit for gate charge behavior) | -                               | 27   | -    | nC   |
| $Q_{gs}$                   | Gate-source charge            |  | -                               | 4    | -    | nC   |
| $Q_{gd}$                   | Gate-drain charge             |  | -                               | 14   | -    | nC   |
| $R_g$                      | Gate input resistance         |  | $f = 1\text{ MHz}$ , open drain | -    | 4.7  | -    |

1.  $C_{oss\text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

**Table 6. Switching times**

| Symbol       | Parameter           | Test conditions   | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 300\text{ V}$ , $I_D = 5.5\text{ A}$ ,<br>$R_G = 4.7\text{ }\Omega$ , $V_{GS} = 10\text{ V}$  | -    | 3    | -    | ns   |
| $t_r$        | Rise time           |   | -    | 8    | -    | ns   |
| $t_{d(off)}$ | Turn-off delay time | (see Figure 16. Test circuit for resistive load switching times and Figure 21. Switching time waveform) | -    | 30   | -    | ns   |
| $t_f$        | Fall time           |   | -    | 10   | -    | ns   |

**Table 7. Source-drain diode**

| Symbol          | Parameter                     | Test conditions   | Min. | Typ. | Max. | Unit          |
|-----------------|-------------------------------|---|------|------|------|---------------|
| $I_{SD}$        | Source-drain current          |   | -    |      | 11   | A             |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |   | -    |      | 44   | A             |
| $V_{SD}^{(2)}$  | Forward on voltage            | $V_{GS} = 0\text{ V}$ , $I_{SD} = 11\text{ A}$                                      | -    |      | 1.5  | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 11\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ ,                       | -    | 230  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       | $V_{DD} = 100\text{ V}$   | -    | 2    |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      | (see Figure 18. Test circuit for inductive load switching and diode recovery times) | -    | 18   |      | A             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 11\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ ,                       | -    | 290  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       | $V_{DD} = 100\text{ V}$ , $T_J = 150\text{ }^\circ\text{C}$                         | -    | 2.5  |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      | (see Figure 18. Test circuit for inductive load switching and diode recovery times) | -    | 17   |      | A             |

1. Pulse width is limited by safe operating area.

2. Pulse test: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

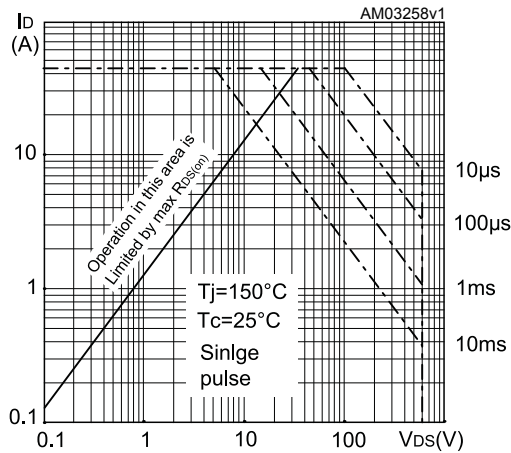
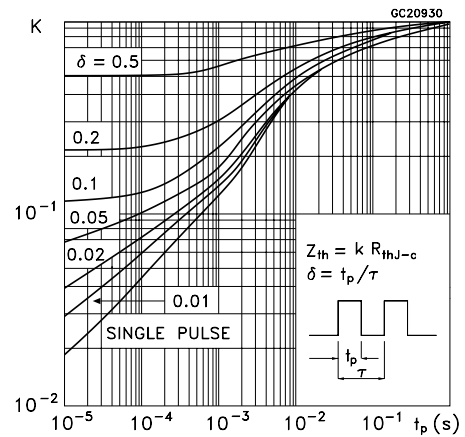
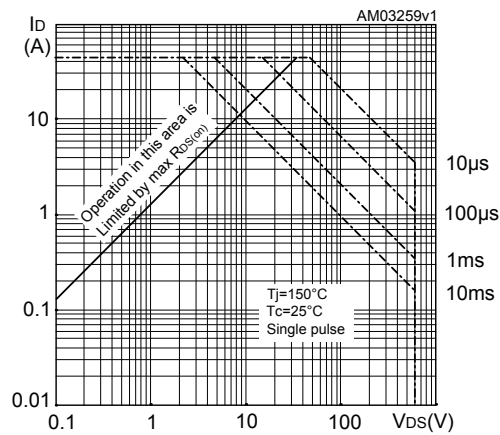
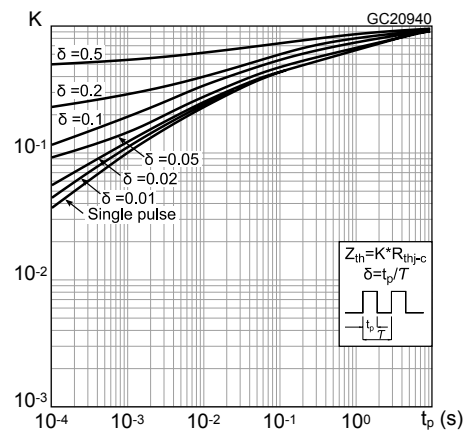
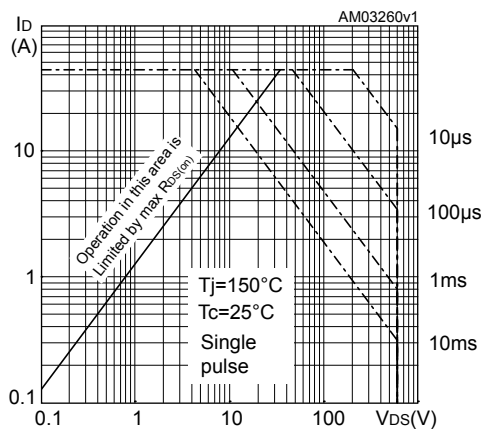
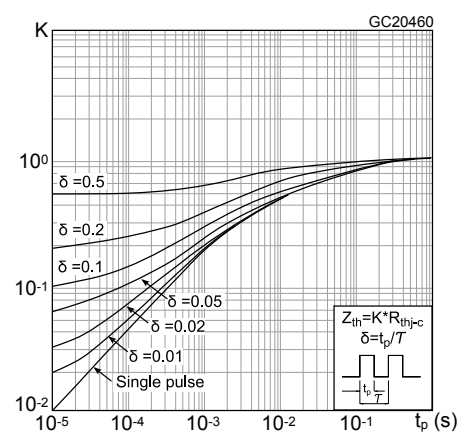
**2.1 Electrical characteristics (curves)**
**Figure 1. Safe operating area for I<sup>2</sup>PAK and TO-220**

**Figure 2. Thermal impedance for I<sup>2</sup>PAK and TO-220**

**Figure 3. Safe operating area for TO-220FP**

**Figure 4. Thermal impedance for TO-220FP**

**Figure 5. Safe operating area for IPAK**

**Figure 6. Thermal impedance for IPAK**


Figure 7. Output characteristics

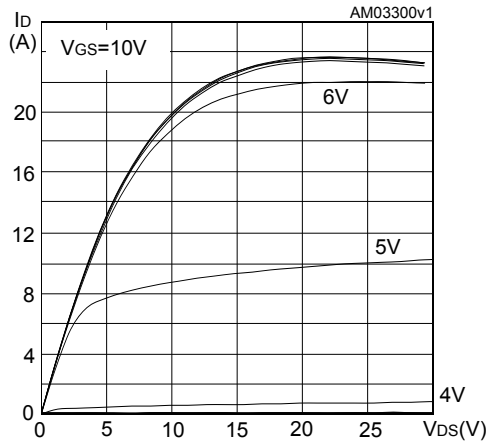


Figure 8. Transfer characteristics

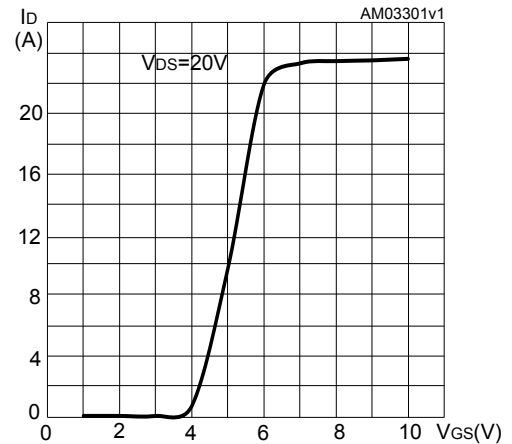


Figure 9. Normalized  $V_{DS}$  vs temperature

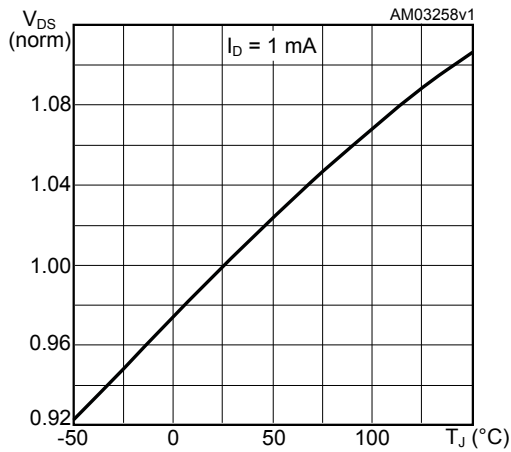


Figure 10. Static drain-source on-resistance

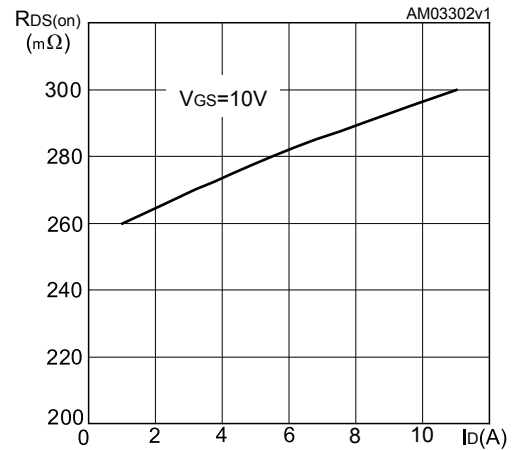


Figure 11. Gate charge vs gate-source voltage

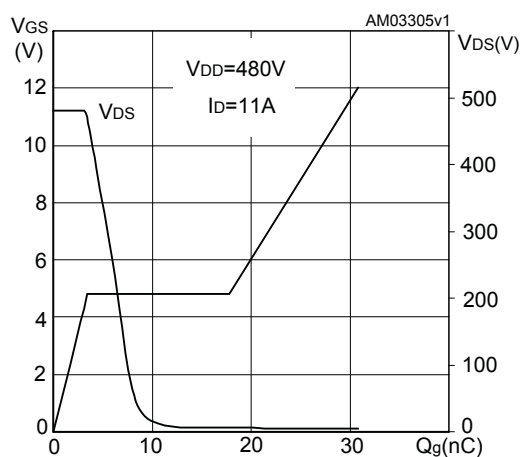
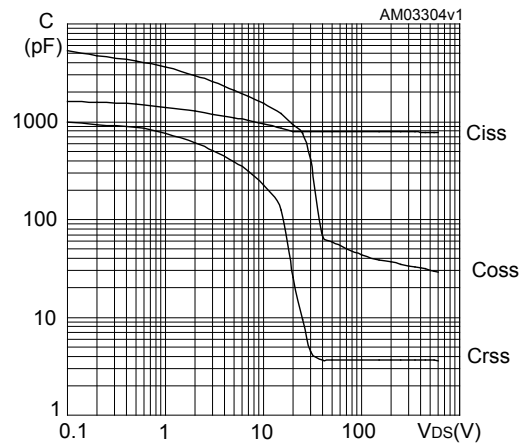
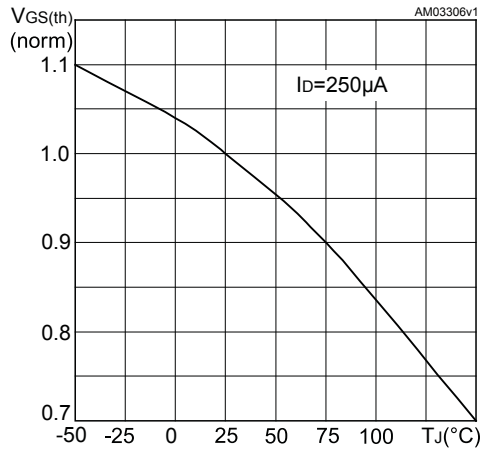
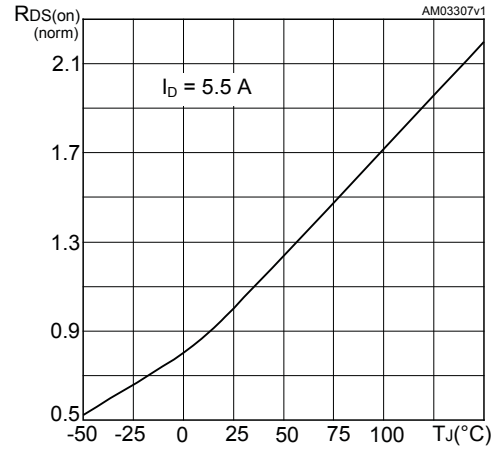
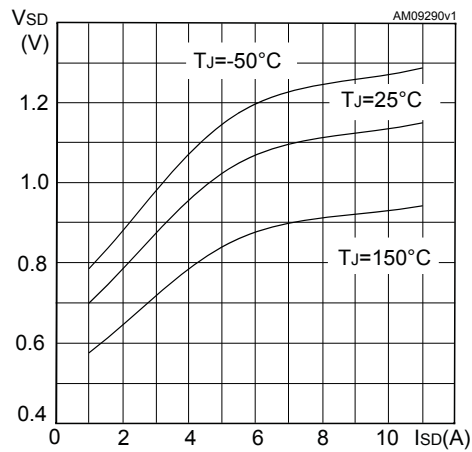


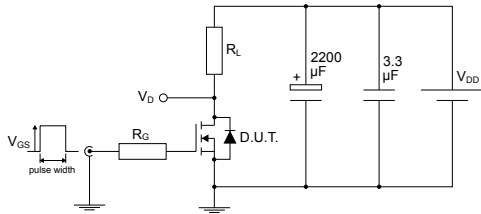
Figure 12. Capacitance variations



**Figure 13. Normalized gate threshold voltage vs temperature**

**Figure 14. Normalized on resistance vs temperature**

**Figure 15. Source-drain diode forward characteristics**


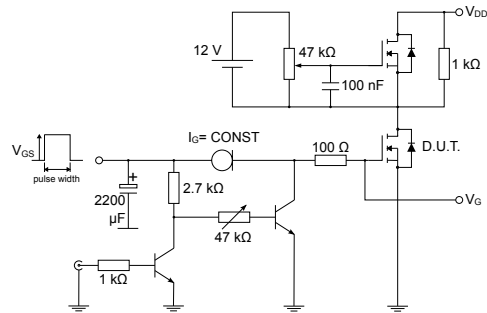
### 3 Test circuits

Figure 16. Test circuit for resistive load switching times



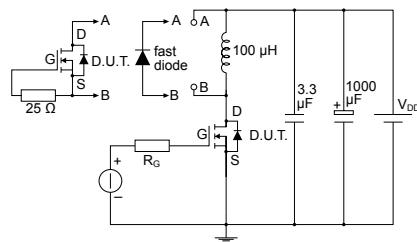
AM01468v1

Figure 17. Test circuit for gate charge behavior



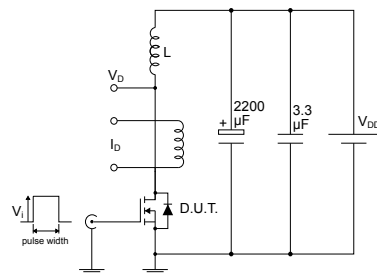
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Figure 18. Test circuit for inductive load switching and diode recovery times



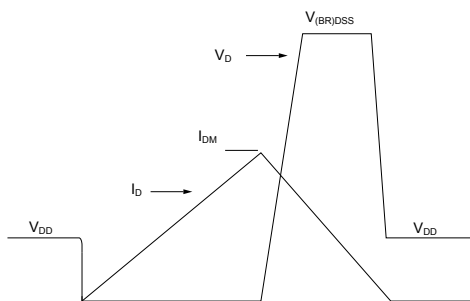
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Figure 19. Unclamped inductive load test circuit



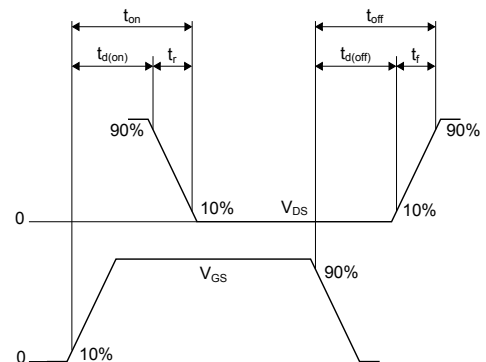
AM01471v1

Figure 20. Unclamped inductive waveform



AM01472v1

Figure 21. Switching time waveform



AM01473v1

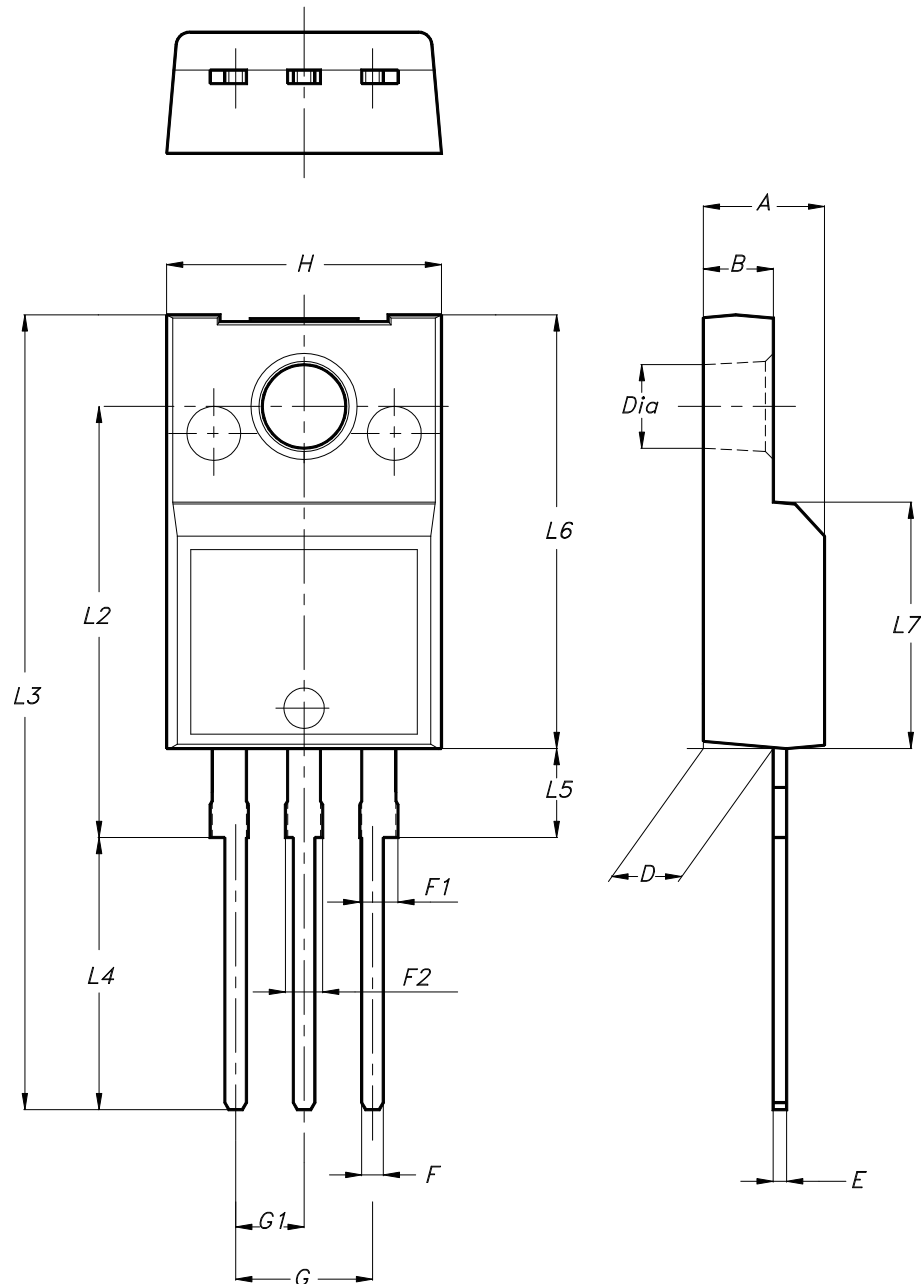


## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 TO-220FP package information

Figure 22. TO-220FP package outline



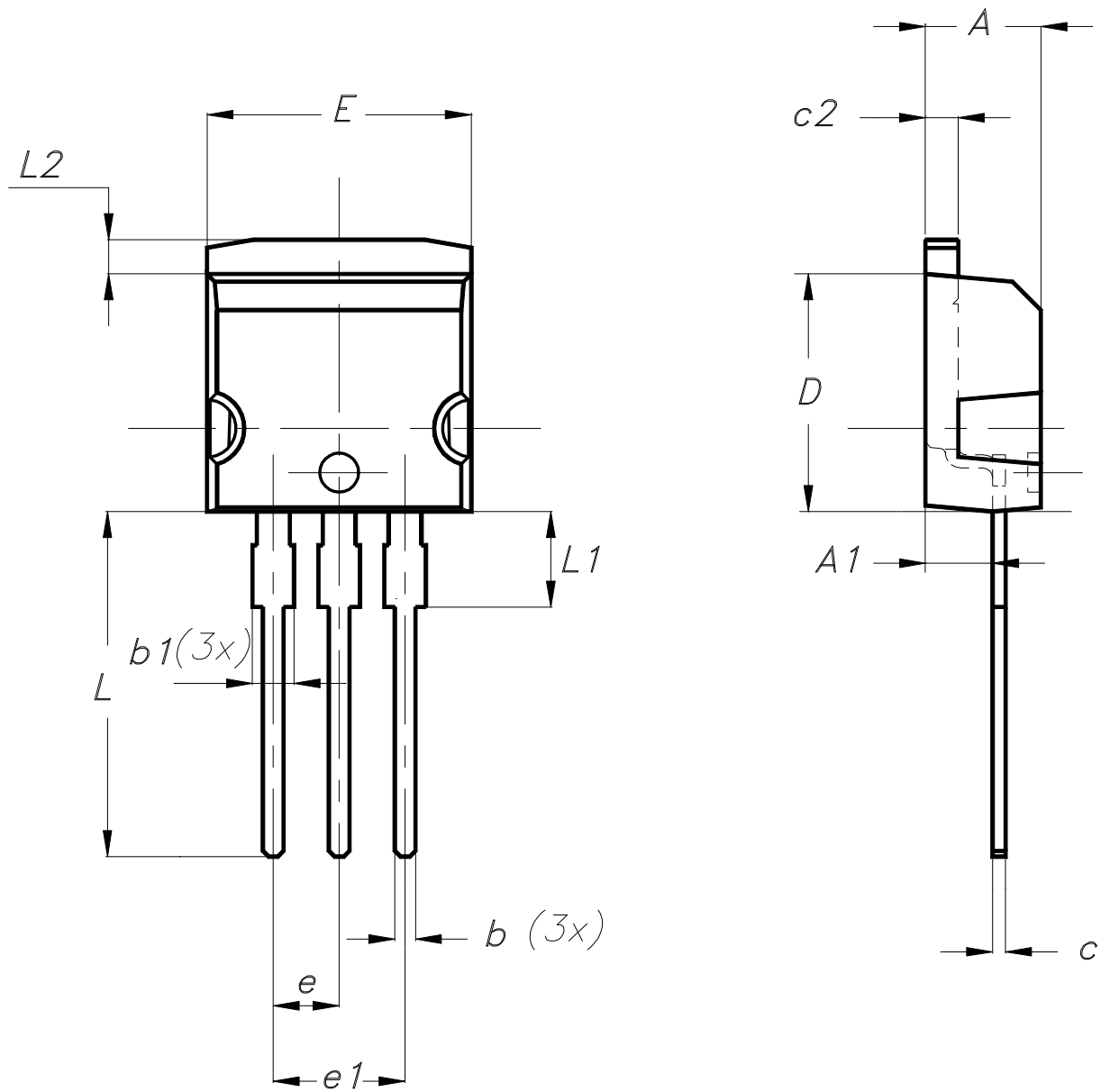
7012510\_Rev\_13\_B

**Table 8. TO-220FP package mechanical data**

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.40  |       | 4.60  |
| B    | 2.50  |       | 2.70  |
| D    | 2.50  |       | 2.75  |
| E    | 0.45  |       | 0.70  |
| F    | 0.75  |       | 1.00  |
| F1   | 1.15  |       | 1.70  |
| F2   | 1.15  |       | 1.70  |
| G    | 4.95  |       | 5.20  |
| G1   | 2.40  |       | 2.70  |
| H    | 10.00 |       | 10.40 |
| L2   |       | 16.00 |       |
| L3   | 28.60 |       | 30.60 |
| L4   | 9.80  |       | 10.60 |
| L5   | 2.90  |       | 3.60  |
| L6   | 15.90 |       | 16.40 |
| L7   | 9.00  |       | 9.30  |
| Dia  | 3.00  |       | 3.20  |

## 4.2 I<sup>2</sup>PAK package information

Figure 23. I<sup>2</sup>PAK package outline



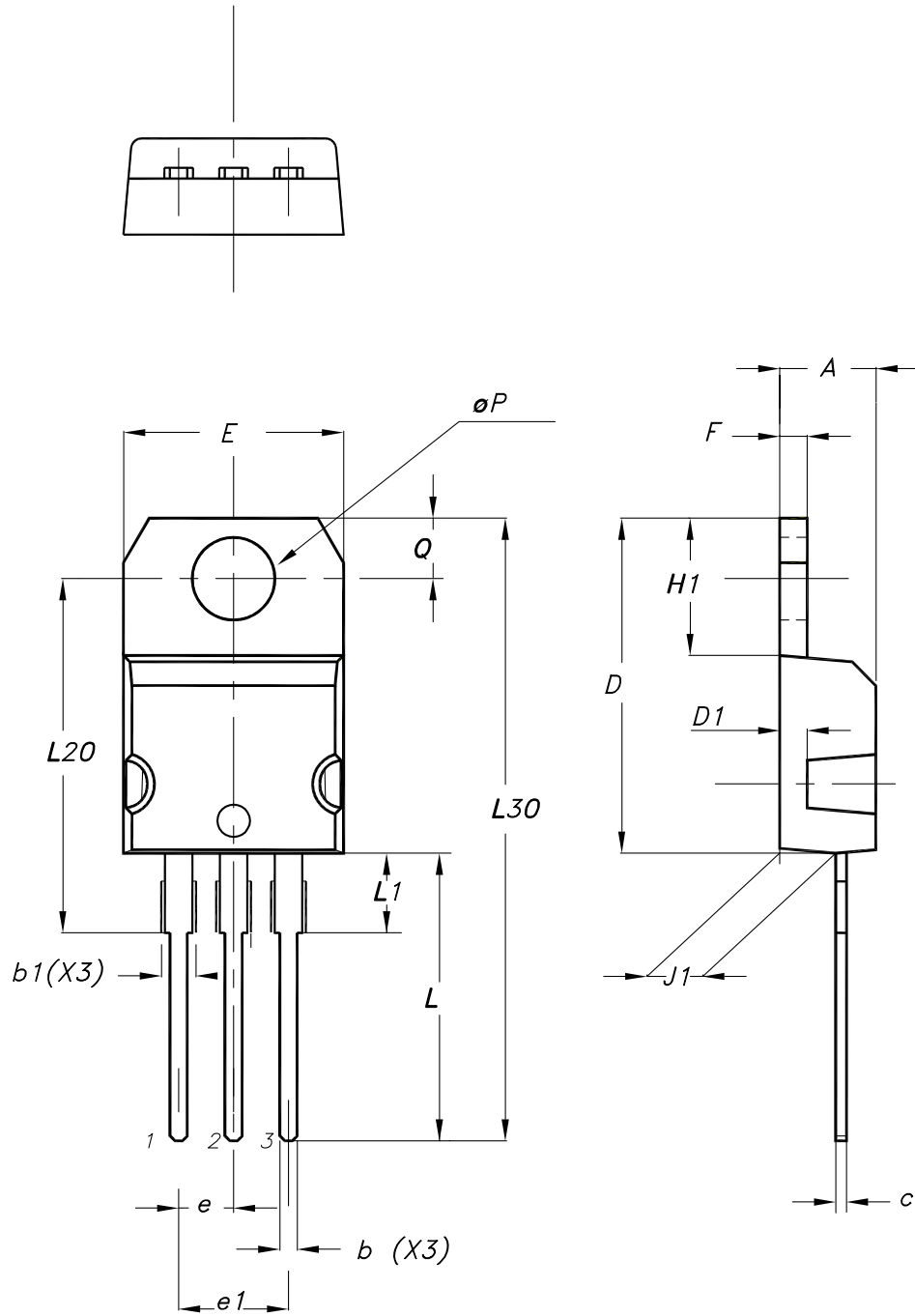
0004982\_Rev\_9

**Table 9. I<sup>2</sup>PAK package mechanical data**

| Dim. | mm    |      |       |
|------|-------|------|-------|
|      | Min.  | Typ. | Max.  |
| A    | 4.40  | -    | 4.60  |
| A1   | 2.40  | -    | 2.72  |
| b    | 0.61  | -    | 0.88  |
| b1   | 1.14  | -    | 1.70  |
| c    | 0.49  | -    | 0.70  |
| c2   | 1.23  | -    | 1.32  |
| D    | 8.95  | -    | 9.35  |
| e    | 2.40  | -    | 2.70  |
| e1   | 4.95  | -    | 5.15  |
| E    | 10.00 | -    | 10.40 |
| L    | 13.00 | -    | 14.00 |
| L1   | 3.50  | -    | 3.93  |
| L2   | 1.27  | -    | 1.40  |

### 4.3 TO-220 type A package information

Figure 24. TO-220 type A package outline



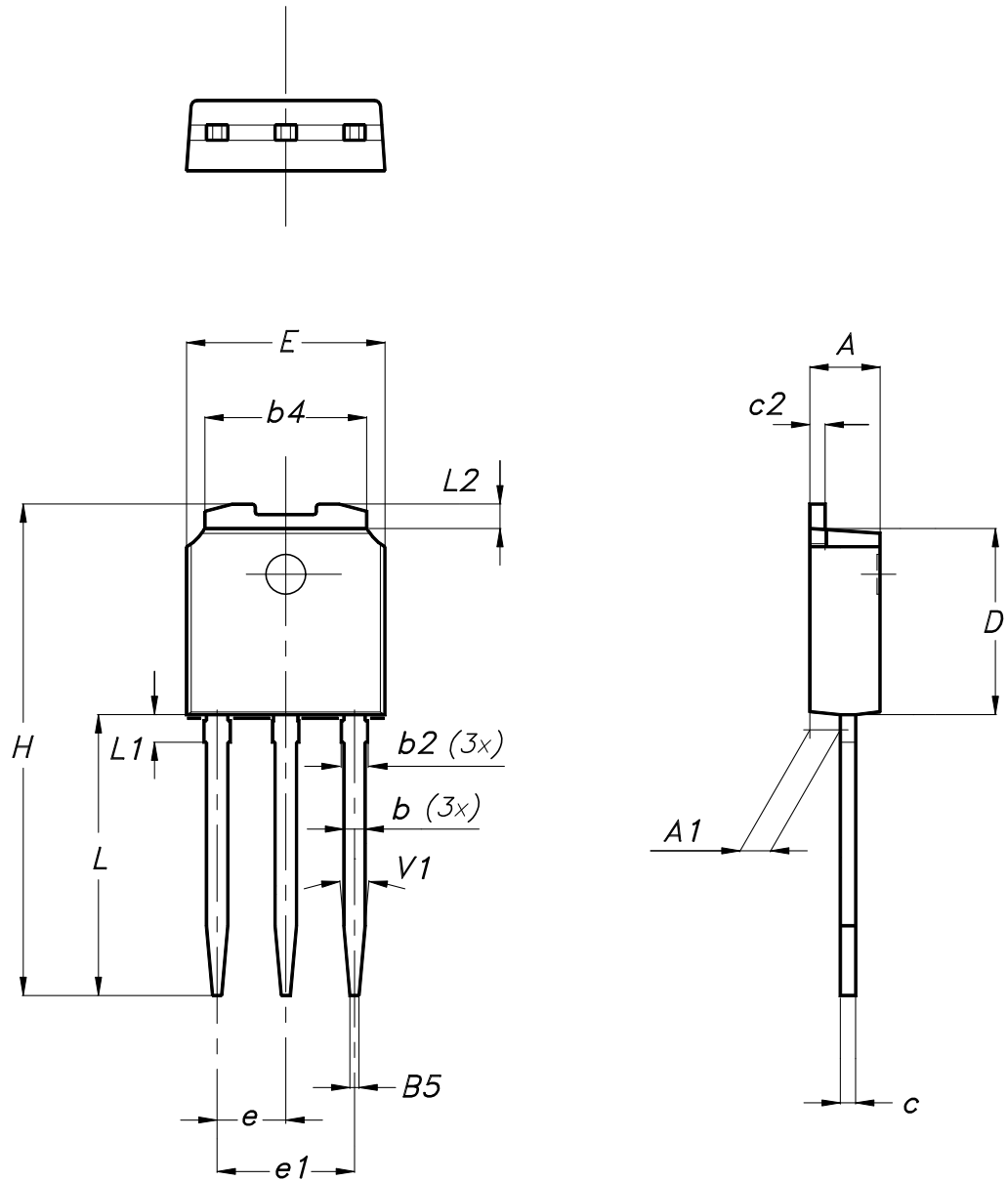
0015988\_typeA\_Rev\_23

**Table 10. TO-220 type A package mechanical data**

| Dim.          | mm    |       |       |
|---------------|-------|-------|-------|
|               | Min.  | Typ.  | Max.  |
| A             | 4.40  |       | 4.60  |
| b             | 0.61  |       | 0.88  |
| b1            | 1.14  |       | 1.55  |
| c             | 0.48  |       | 0.70  |
| D             | 15.25 |       | 15.75 |
| D1            |       | 1.27  |       |
| E             | 10.00 |       | 10.40 |
| e             | 2.40  |       | 2.70  |
| e1            | 4.95  |       | 5.15  |
| F             | 1.23  |       | 1.32  |
| H1            | 6.20  |       | 6.60  |
| J1            | 2.40  |       | 2.72  |
| L             | 13.00 |       | 14.00 |
| L1            | 3.50  |       | 3.93  |
| L20           |       | 16.40 |       |
| L30           |       | 28.90 |       |
| øP            | 3.75  |       | 3.85  |
| Q             | 2.65  |       | 2.95  |
| Slug flatness |       | 0.03  | 0.10  |

#### 4.4 IPAK (TO-251) type A package information

Figure 25. IPAK (TO-251) type A package outline



0068771\_IK\_typeA\_rev15

Table 11. IPAK (TO-251) type A package mechanical data

| Dim. | mm   |       |      |
|------|------|-------|------|
|      | Min. | Typ.  | Max. |
| A    | 2.20 |       | 2.40 |
| A1   | 0.90 |       | 1.10 |
| b    | 0.64 |       | 0.90 |
| b2   |      |       | 0.95 |
| b4   | 5.20 |       | 5.40 |
| B5   |      | 0.30  |      |
| c    | 0.45 |       | 0.60 |
| c2   | 0.48 |       | 0.60 |
| D    | 6.00 |       | 6.20 |
| E    | 6.40 |       | 6.60 |
| e    |      | 2.28  |      |
| e1   | 4.40 |       | 4.60 |
| H    |      | 16.10 |      |
| L    | 9.00 |       | 9.40 |
| L1   | 0.80 |       | 1.20 |
| L2   |      | 0.80  | 1.00 |
| V1   |      | 10°   |      |



## 5 Ordering information

Table 12. Order codes

| Order codes | Marking | Package            | Packing |
|-------------|---------|--------------------|---------|
| STF13NM60N  | 13NM60N | TO-220FP           | Tube    |
| STI13NM60N  |         | I <sup>2</sup> PAK |         |
| STP13NM60N  |         | TO-220             |         |
| STU13NM60N  |         | IPAK               |         |

## Revision history

**Table 13. Document revision history**

| Date        | Revision | Changes  |
|-------------|----------|--|
| 29-Feb-2009 | 1        | First release  |
| 13-Jan-2010 | 2        | <ul style="list-style-type: none"> <li>– Added new package, mechanical data: TO-247</li> <li>– Added new package, mechanical data: D<sup>2</sup>PAK</li> </ul>   |
| 08-Nov-2010 | 3        | <ul style="list-style-type: none"> <li>– Modified <i>Figure 4</i></li> <li>– Added new package, mechanical data: I<sup>2</sup>PAK</li> </ul>   |
| 18-Jan-2012 | 4        | <ul style="list-style-type: none"> <li>– Added new package, mechanical data: IPAK</li> <li>– Minor text changes</li> </ul>   |
| 14-Nov-2012 | 5        | <p>The part numbers STB13NM60N and STD13NM60N have been moved to a separate datasheet.</p> <p><i>Section 4: Package mechanical data</i> has been updated.</p>  |
| 26-Oct-2020 | 6        | <p>The part number STW13NM60N have been moved to a separate datasheet and the document has been updated accordingly.</p> <p>Updated cover page.</p> <p>Updated <a href="#">Section 1 Electrical ratings</a>.</p> <p>Updated <a href="#">Table 4. Static</a> and <a href="#">Table 7. Source-drain diode</a>.</p> <p>Updated <a href="#">Section 4 Package information</a>.</p> <p>Added <a href="#">Section 5 Ordering information</a>.</p> <p>Minor text changes.</p> |

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